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SERIAL NUMBER 10/632,553	FILING DATE 08/02/2003 RULE	CLASS 438	GROUP ART UNIT 2818	ATTORNEY DOCKET NO. CPAC 1017-6 D4
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APPLICANTS

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** CONTINUING DATA ***** *dh* *****
 This appln claims benefit of 60/411,590 09/17/2002

** FOREIGN APPLICATIONS ***** *NONE dh* *****

IF REQUIRED, FOREIGN FILING LICENSE GRANTED
 ** 10/30/2003

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY CA	SHEETS DRAWING 7	TOTAL CLAIMS 40	INDEPENDENT CLAIMS 2
35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after met				
Verified and Acknowledged <i>dh</i> <div style="display: flex; justify-content: space-between;"> <div> Allowance <i>dh</i> Examiner's Signature </div> <div> <i>dh</i> Initials </div> </div>				

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TITLE
 Semiconductor multi-package module having package stacked over die-down flip chip ball grid array package and having wire bond interconnect between stacked packages

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